

Click here for the 3D model.


## Packaging Specifications

Packaging
T\&R, 180mm, Paper Tape
Packaging Quantity 4000

| General Information |  |
| :---: | :---: |
| Series | Array Auto X7R Flex |
| Style | SMD Array |
| Description | SMD, MLCC, Array, Flex Termination, Automotive Grade |
| Features | Automotive Grade |
| RoHS | Yes |
| Termination | Flexible Termination |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Typical Component Weight | 23 mg |
| Notes | Last Time Buy Date (LTB): May 30th, 2024. |
| Chip Size | 0612 |
| Shelf Life | 78 Weeks |
| MSL | 1 |


| Specifications | 5600 pF |
| :--- | :--- |
| Capacitance | 1 kHz 1.0 Vrms |
| Measurement Condition | $10 \%$ |
| Capacitance Tolerance | 200 VDC |
| Voltage DC | 500 VDC |
| Dielectric Withstanding Voltage | $-55 /+125^{\circ} \mathrm{C}$ |
| Temperature Range | X 7 R |
| Temperature Coefficient | $15 \%, 1 \mathrm{kHz} 1.0 \mathrm{Vrms}$ |
| Capacitance Change with Reference <br> to $+25^{\circ} \mathrm{C}$ and O VDC Applied (TCC) | $2.5 \% 1 \mathrm{kHz} 1.0 \mathrm{Vrms}$ |
| Dissipation Factor | $3 \%$ Loss/Decade Hour: |
| Aging Rate | 100 GOHms |
| Insulation Resistance |  |

